

# CEP06N5/CEB06N5

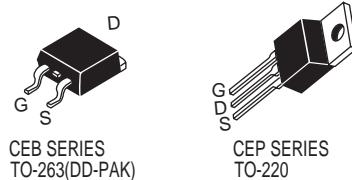
Oct. 2002

## N-Channel Logic Level Enhancement Mode Field Effect Transistor

4

### FEATURES

- 500V , 6.6A ,  $R_{DS(ON)}=1\Omega$  @ $V_{GS}=10V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- TO-220 & TO-263 package.



### ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	500	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Drain Current-Continuous -Pulsed	$I_D$	6.6	A
	$I_{DM}$	20	A
Drain-Source Diode Forward Current	$I_S$	6.6	A
Maximum Power Dissipation @ $T_c=25^\circ C$ Derate above 25°C	$P_D$	104	W
		0.83	W/°C
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.2	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

# CEP06N5/CEB06N5

4

## ELECTRICAL CHARACTERISTICS (T<sub>c</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>DRAIN-SOURCE AVALANCHE RATING<sup>a</sup></b>						
Single Pulse Drain-Source Avalanche Energy	E <sub>AS</sub>	V <sub>DD</sub> = 50V, L = 24mH R <sub>G</sub> = 25Ω		500		mJ
Maximum Drain-Source Avalanche Current	I <sub>AS</sub>			6		A
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	500			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 500V, V <sub>GS</sub> = 0V			25	μA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V			±100	nA
<b>ON CHARACTERISTICS<sup>a</sup></b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2		4	V
Drain-Source On-State Resistance	R <sub>D(S)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 4A		0.85	1.0	Ω
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 10V	6			A
Forward Transconductance	g <sub>F</sub>	V <sub>DS</sub> = 50V, I <sub>D</sub> = 4A		4		S
<b>SWITCHING CHARACTERISTICS<sup>b</sup></b>						
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> = 250V, I <sub>D</sub> = 6A, V <sub>GS</sub> = 10V R <sub>GEN</sub> = 18Ω		23	45	ns
Rise Time	t <sub>r</sub>			35	70	ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			162	240	ns
Fall Time	t <sub>f</sub>			44	90	ns
Total Gate Charge	Q <sub>g</sub>			54	65	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 400V, I <sub>D</sub> = 6A, V <sub>GS</sub> = 10V		9		nC
Gate-Drain Charge	Q <sub>gd</sub>			27		nC

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4

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>DYNAMIC CHARACTERISTICS<sup>b</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS}=25\text{V}, V_{GS}=0\text{V}$ $f=1.0\text{MHz}$	823			pF
Output Capacitance	$C_{oss}$		110			pF
Reverse Transfer Capacitance	$C_{rss}$		64			pF
<b>DRAIN-SOURCE DIODE CHARACTERISTICS<sup>a</sup></b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0\text{V}, I_S=6\text{A}$			1.5	V

### Notes

a.Pulse Test:Pulse Width $\leq 300\ \mu\text{s}$ , Duty Cycle $\leq 2\%$ .

b.Guaranteed by design, not subject to production testing.

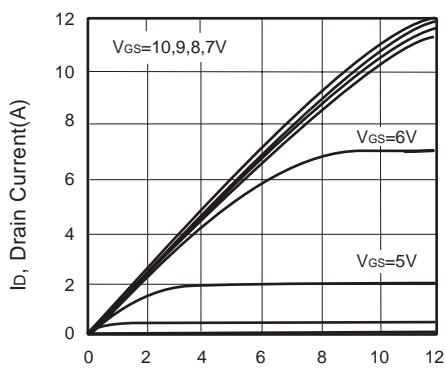


Figure 1. Output Characteristics

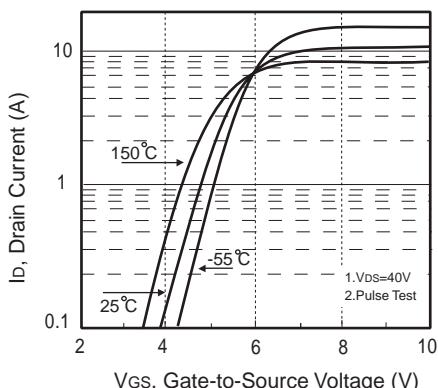
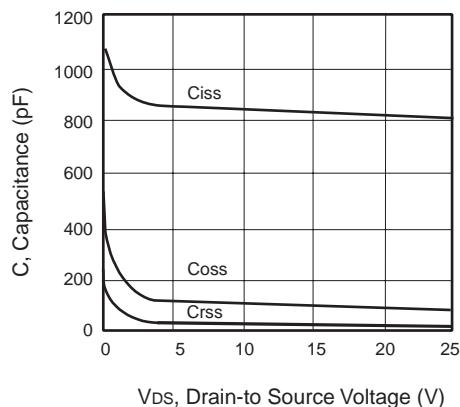


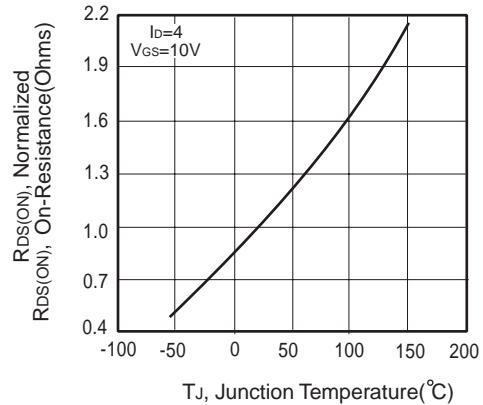
Figure 2. Transfer Characteristics

# CEP06N5/CEB06N5

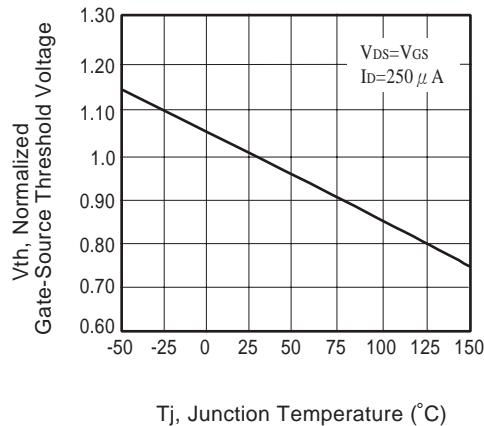
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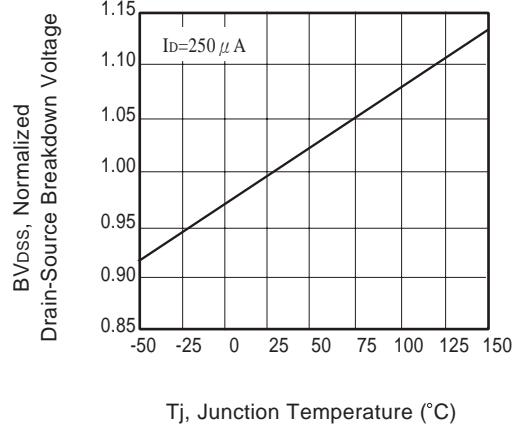
**Figure 3. Capacitance**



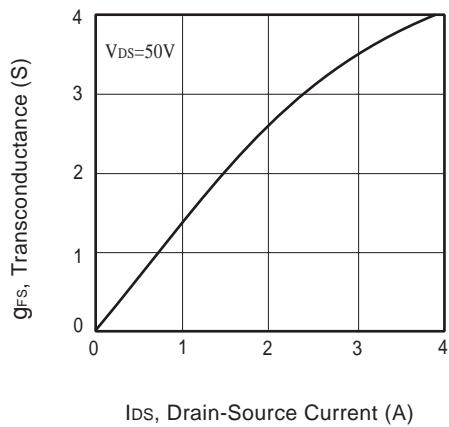
**Figure 4. On-Resistance Variation with Temperature**



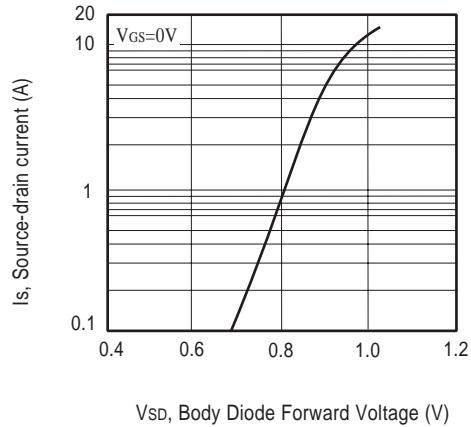
**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Breakdown Voltage Variation with Temperature**

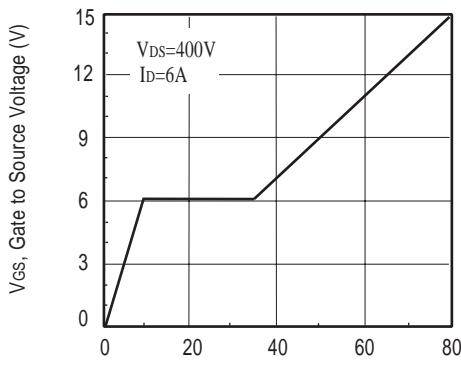


**Figure 7. Transconductance Variation with Drain Current**

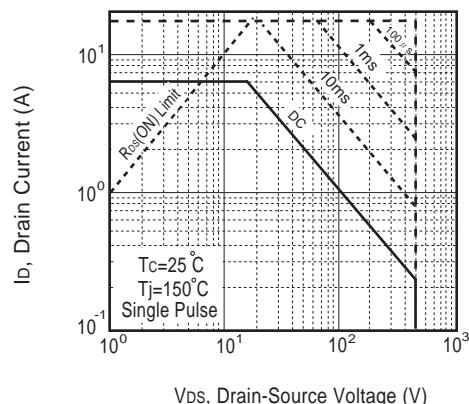


**Figure 8. Body Diode Forward Voltage Variation with Source Current**

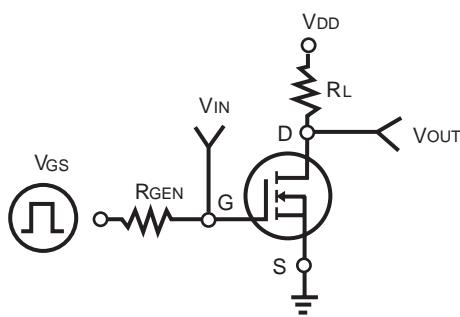
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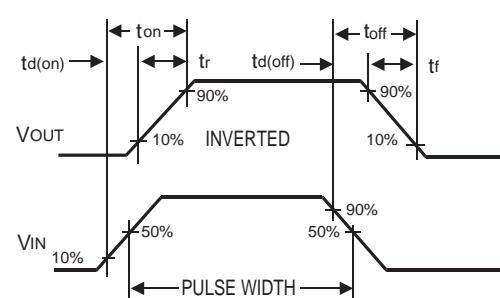
**Figure 9. Gate Charge**



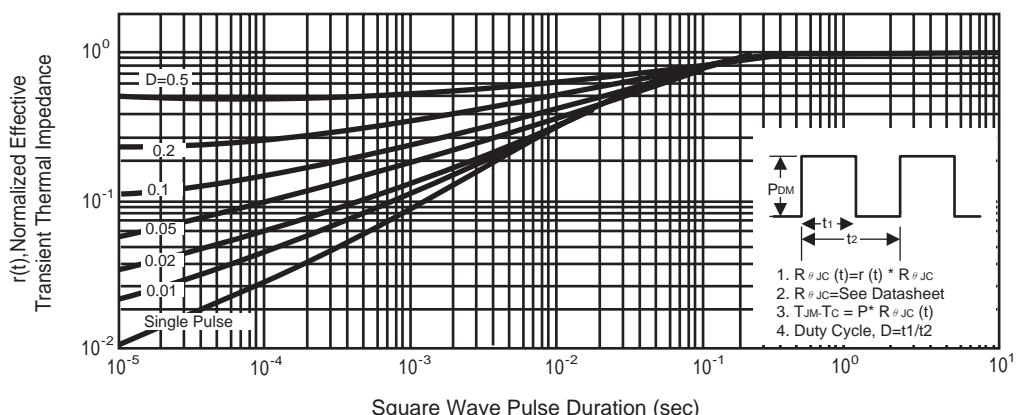
**Figure 10. Maximum Safe Operating Area**



**Figure 11. Switching Test Circuit**



**Figure 12. Switching Waveforms**



**Figure 13. Normalized Thermal Transient Impedance Curve**